

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT3317266

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TREVOR BRAUN	04/10/2015
DANIEL T. SCHWARTZ	04/10/2015
RECEIVING PARTY DATA	
Name:	Washington, University of
Street Address:	4311 11th Avenue NE, Suite 500
City:	Seattle
State/Country:	WASHINGTON
Postal Code:	98105-4608
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14666554
CORRESPONDENCE DATA	
Fax Number:	(206)224-0779
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	(206)682-8100
Email:	efiling@cojk.com
Correspondent Name:	RYAN E. DODGE, JR., ESQ.
Address Line 1:	CHRISTENSEN O'CONNOR JOHNSON KINDNESS
Address Line 2:	1201 THIRD AVENUE, SUITE 3600
Address Line 4:	SEATTLE, WASHINGTON 98101-3029
ATTORNEY DOCKET NUMBER:	UWOTL153493
NAME OF SUBMITTER:	RYAN E. DODGE, JR.
SIGNATURE:	/RYAN E. DODGE, JR./
DATE SIGNED:	04/20/2015
Total Attachments: 2	
source=53493_Assignment#page1.tif	
source=53493_Assignment#page2.tif	

ASSIGNMENT

to

The University of Washington
Seattle, Washington

WHEREAS, Trevor Braun and Daniel T. Schwartz have made a certain invention in Bipolar Electrochemical Printing for which Trevor Braun and Daniel T. Schwartz have executed an application for Letters Patent filed in the U.S. Patent Office on March 24, 2015, as Application No. 14/666554; and

WHEREAS, the University of Washington, a public institution of higher education having a place of business at Seattle, Washington, is desirous of acquiring an interest in said invention and in any patent or patents to be obtained therefor;

NOW, THEREFORE, for sufficient, good, and valuable consideration, the receipt of which is hereby acknowledged, Trevor Braun and Daniel T. Schwartz hereby sell, assign, and transfer unto the University of Washington the entire right and title to and interest in said application and said invention for the United States of America and its territorial possessions and all foreign countries, and the entire right and title to and interest in any and all letters patents which may be granted therefor in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, and continuations thereof;

And Trevor Braun and Daniel T. Schwartz further covenant and agree that Trevor Braun and Daniel T. Schwartz will, at the request and expense of said University of Washington, execute such other and further assurances of title as may be necessary or proper to fully convey the interest herein sought to be conveyed; that Trevor Braun and Daniel T. Schwartz will, at the request and expense of said University of Washington, execute such application papers as may be desired by said University of Washington for the filing of any continuation, division, or renewal of the application herein conveyed, or for reissues or extensions of any Letters Patent that may be granted upon said application, and will execute such supplemental oaths and preliminary statements or other papers as desired by said University of Washington.

And Trevor Braun and Daniel T. Schwartz further assign unto said University of Washington the entire right and title to and interest in said invention throughout all countries foreign to the United States, and do hereby authorize said University of Washington to apply for international patents and patents therefor in its own name in countries where such procedure is proper and to claim the benefit of the International Convention, and do agree to execute applications for said invention in the several countries where it is necessary that the same be executed by the inventors and to execute assignment of such applications and the patents to be obtained therefor to said University of Washington, the assignee herein, as well as all other necessary papers.

